

DATA SHEET

Order code	Manufacturer code	Description
38-1024	GP2500-0.040-02-0404	GAP PAD 2500 0.040" 4" X 4" SHEET RC
38-1026	GP2500-0.080-02-0404	GAP PAD 2500 0.080" 4" X 4" SHEET RC
38-1028	GP2500-0.125-02-0404	GAP PAD 2500 0.125" 4" X 4" SHEET RC

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The enclosed information is believed to be correct, Information may change awithout noticeqdue to product improvement. Users should ensure that the product is suitable for their use. E. & O. E.	Revision A 20/02/2007

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Gap Pad® 2500

Thermally Conductive, Unreinforced Gap Filling Material

Features and Benefits

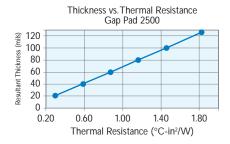
- Thermal conductivity: 2.7 W/m-K
- High thermal performance, cost-effective solution
- Unreinforced construction for additional compliancy
- · Medium compliancy and conformability



Gap Pad 2500 is a thermally conductive, electrically insulating, unreinforced gap filling material. Gap Pad 2500 is a filled-polymer material yielding an elastic polymer that allows for easy handling and converting without the need for reinforcement. These properties also allow for good wet-out and interfacing characteristics to surfaces with roughness and/or topography. All these characteristics make this material ideal for applications using either clip or screw-mounted assemblies.

Gap Pad 2500 is offered with inherent natural tack on both sides of the material allowing for stick-in-place characteristics during application assembly. The material is supplied with protective liners on both sides.

Note: Resultant thickness is defined as the final gap thickness of the application.



TYPICAL PROPERTIES OF GAP PAD 2500 PROPERTY IMPERIAL VALUE **METRIC VALUE** TEST METHOD Color Light Brown Light Brown Visual Reinforcement Carrier Thickness (inch) / (mm) 0.020 to 0.125 0.508 to 3.175 ASTM D374 Inherent Surface Tack (1- or 2-sided) Density (g/cc) 3.1 3 1 ASTM D792 Heat Capacity (J/g-K) 1.0 1.0 ASTM E1269 Hardness, Bulk Rubber (Shore 00) (1) 80 80 ASTM D2240 Young's Modulus (psi) / (kPa) (2) 113 779 ASTM D575 -76 to 392 -60 to 200 Continuous Use Temp (°F) / (°C) **ELECTRICAL** Dielectric Breakdown Voltage (Vac) >6000 >6000 ASTM D149 Dielectric Constant (1000 Hz) ASTM D150 6.8 6.8 Volume Resistivity (Ohm-meter) 101 101 ASTM D257 V-O V-O U.L. 94 Flame Rating **THERMAL** Thermal Conductivity (W/m-K) 2.7 27 ASTM D5470

1) Thirty second delay value Shore 00 hardness scale.

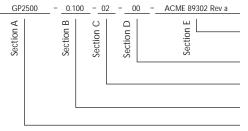
Typical Applications Include:

- Multiple heat-generating components to a common heat sink
- · Graphics chips to heat sinks
- · Processors to heat sinks
- Mass storage drives
- Wireline / wireless communications hardware

Configurations Available:

• Sheet form and die-cut parts

Building a Part Number



Standard Options

NA = Selected standard option. If not selecting a standard option, insert company name, drawing number, and revision level.

0816 = Standard sheet size 8" x 16", or 00 = custom configuration

02 = Natural tack, both sides

Standard thicknesses available: 0.020", 0.040", 0.060", 0.080", 0.100", 0.125"

GP2500 = Gap Pad 2500 Material

Note: To build a part number, visit our website at www.bergquistcompany.com.

Gap Pad®: U.S. Patent 5,679,457 and others.

Young's Modulus, calculated using 0.01 in/min. step rate of strain with a sample size of 0.79 inch². For more information on Gap Pad modulus, refer to Bergquist Application Note #116.